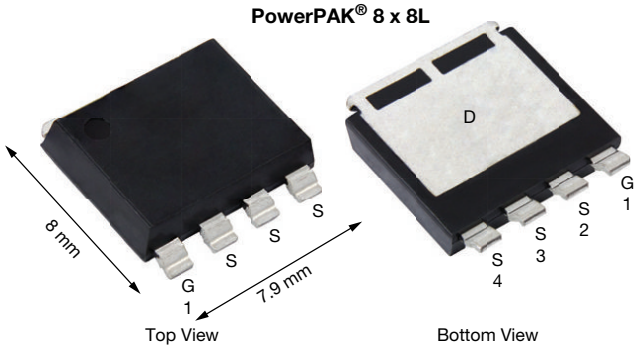
Automotive N-Channel 100 V (D-S) 175 °C MOSFET



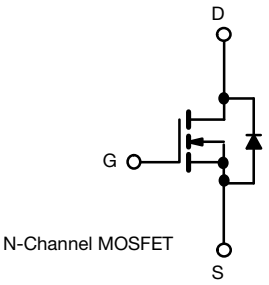
FEATURES

- TrenchFET® Gen IV power MOSFET
- AEC-Q101 qualified
- 100 % R_g and UIS tested
- Thin 1.9 mm height
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

AUTOMOTIVE GRADE

RoHS COMPLIANT

HALOGEN FREE



PRODUCT SUMMARY	
V_{DS} (V)	100
$R_{DS(on)}$ (Ω) at V_{GS} = 10 V	0.0055
$R_{DS(on)}$ (Ω) at V_{GS} = 4.5 V	0.0062
I_D (A) [e]	136
Configuration	Single

ORDERING INFORMATION	
Package	PowerPAK 8 x 8L
Lead (Pb)-free and halogen-free	SQJQ114EL (for detailed order number please see www.vishay.com/doc?79776)

ABSOLUTE MAXIMUM RATINGS (T_C = 25 °C, unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V_{DS}	100	V
Gate-source voltage		V_{GS}	± 20	
Continuous drain current [e]	T_C = 25 °C	I_D	136	A
	T_C = 125 °C		78	
Continuous source current (diode conduction) [e]		I_S	252	
Pulsed drain current [a, e]		I_{DM}	311	
Single pulse avalanche current	L = 0.1 mH	I_{AS}	46	
Single pulse avalanche energy		E_{AS}	105	mJ
Maximum power dissipation [e]	T_C = 25 °C	P_D	277	W
	T_C = 125 °C		92	
Operating junction and storage temperature range		T_J, T_{stg}	-55 to +175	°C
Soldering recommendations (peak temperature) [c]			260	

THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient	PCB mount [b]	R_{thJA}	44	°C/W
Junction-to-case (drain) [d]		R_{thJC}	0.54	

Notes

a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %
b. When mounted on 1" square PCB (FR4 material)
c. See solder profile (www.vishay.com/doc?73257)
d. As per JESD51-14
e. Values based on R_{thJC} and T_C of 25 °C. Actual values achievable will be dependent on the thermal characteristics of the complete system

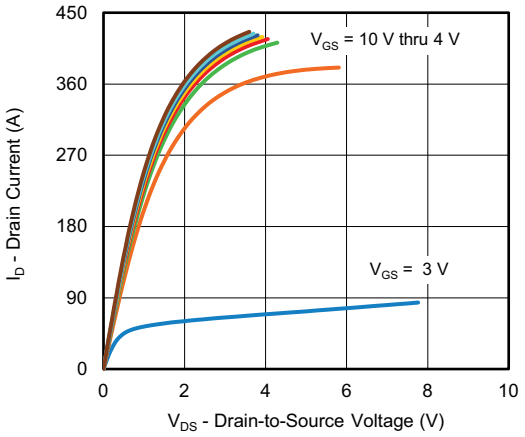
SPECIFICATIONS (T_C = 25 °C, unless otherwise noted)							
PARAMETER	**SYMBOL**	**TEST CONDITIONS**		**MIN.**	**TYP.**	**MAX.**	**UNIT**
Static							
Drain-source breakdown voltage	V_{DS}	V_{GS} = 0, I_D = 250 µA		100	-	-	V
Gate-source threshold voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250 µA		1.4	1.9	2.4	
Gate-source leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V		-	-	± 100	nA
Zero gate voltage drain current	I_{DSS}	V_{GS} = 0 V	V_{DS} = 100 V	-	-	1	µA
		V_{GS} = 0 V	V_{DS} = 100 V, T_J = 125 °C	-	-	50	
		V_{GS} = 0 V	V_{DS} = 100 V, T_J = 175 °C	-	-	500	
On-state drain current [a]	$I_{D(on)}$	V_{GS} = 10 V	V_{DS} ≥ 5 V	50	-	-	A
Drain-source on-state resistance [a]	$R_{DS(on)}$	V_{GS} = 10 V	I_D = 20 A	-	0.0035	0.0055	Ω
		V_{GS} = 10 V	I_D = 20 A, T_J = 125 °C	-	-	0.0120	
		V_{GS} = 10 V	I_D = 20 A, T_J = 175 °C	-	-	0.0150	
		V_{GS} = 4.5 V	I_D = 20 A	-	0.0048	0.0062	
Forward transconductance [b]	g_{fs}	V_{DS} = 15 V, I_D = 15 A		-	165	-	S
Dynamic [b]							
Input capacitance	C_{iss}	V_{GS} = 0 V	V_{DS} = 25 V, f = 1 MHz	-	6428	9000	pF
Output capacitance	C_{oss}			-	618	866	
Reverse transfer capacitance	C_{rss}			-	39	55	
Total gate charge [c]	Q_g	V_{GS} = 10 V	V_{DS} = 50 V, I_D = 20 A	-	102	158	nC
Gate-source charge [c]	Q_{gs}			-	20	-	
Gate-drain charge [c]	Q_{gd}			-	14	-	
Gate resistance	R_g	f = 1 MHz		0.5	1.1	1.8	Ω
Turn-on delay time [c]	$t_{d(on)}$	V_{DD} = 50 V, R_L = 2.5 Ω, I_D ≅ 20 A, V_{GEN} = 10 V, R_g = 1 Ω		-	14	22	ns
Rise time [c]	t_r			-	4	8	
Turn-off delay time [c]	$t_{d(off)}$			-	47	71	
Fall time [c]	t_f			-	6	9	
Source-Drain Diode Ratings and Characteristics [b]							
Pulsed current [a]	I_{SM}			-	-	311	A
Forward voltage	V_{SD}	I_F = 40 A, V_{GS} = 0 V		-	0.7	1.1	V
Body diode reverse recovery time	t_{rr}	I_F = 15 A, di/dt = 100 A/µs		-	49	98	ns
Body diode reverse recovery charge	Q_{rr}			-	91	182	nC
Reverse recovery fall time	t_a			-	40	-	ns
Reverse recovery rise time	t_b			-	10	-	
Body diode peak reverse recovery current	$I_{RM(REC)}$			-	3.4	-	A

Notes

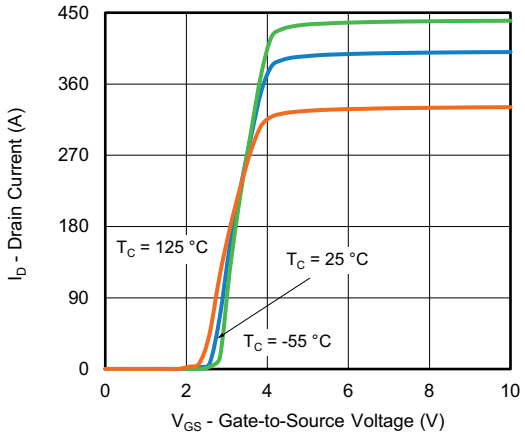
a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %
b. Guaranteed by design, not subject to production testing
c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

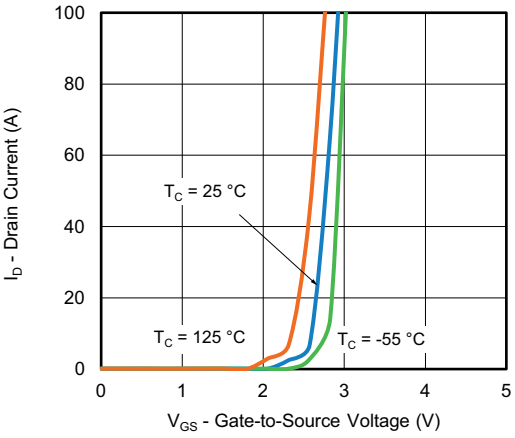
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



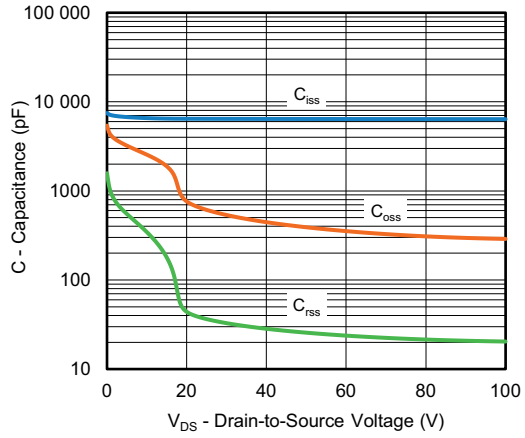
Output Characteristics



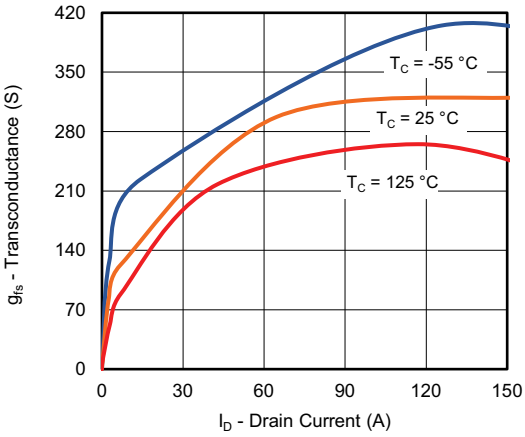
Transfer Characteristics



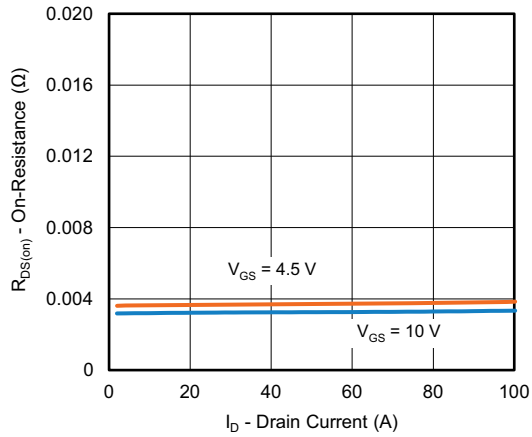
Transfer Characteristics



Capacitance

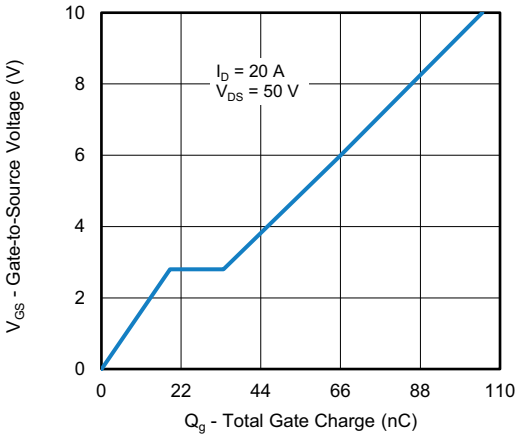


Transconductance

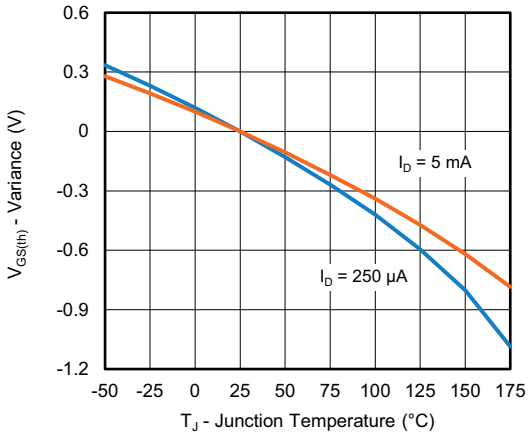


On-Resistance vs. Drain Current

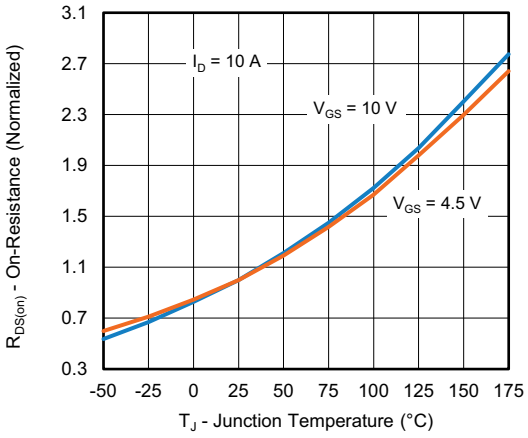
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



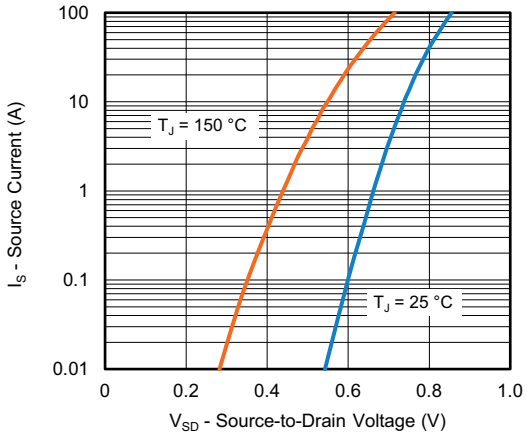
Gate Charge



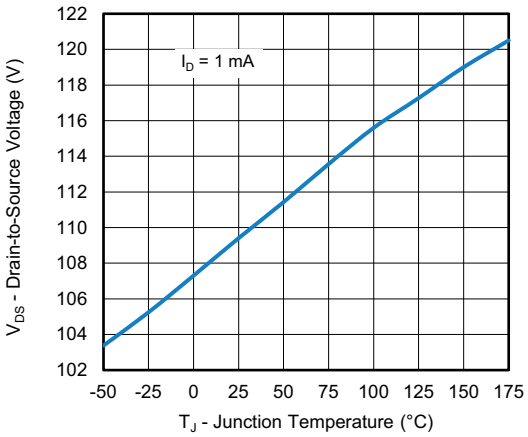
Threshold Voltage



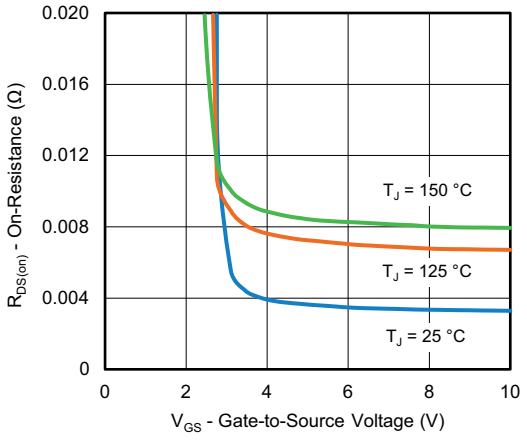
On-Resistance vs. Junction Temperature



Source Drain Diode Forward Voltage



Drain Source Breakdown vs. Junction Temperature

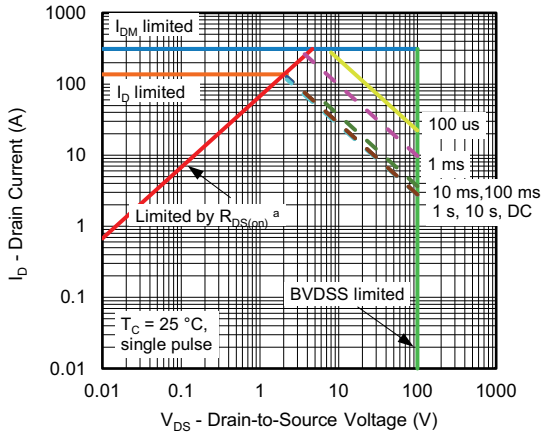


On-Resistance vs. Gate-to-Source Voltage

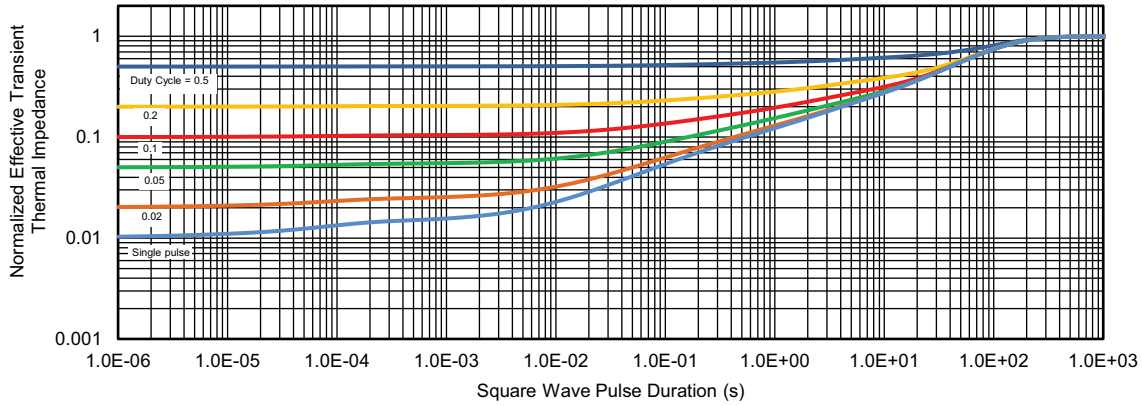
Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

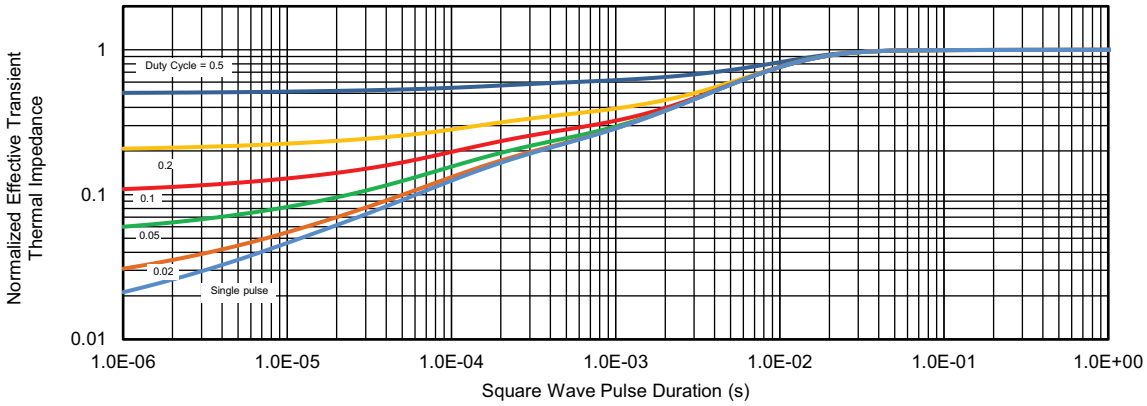
THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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